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STGE50NC60VD

50 A - 600 V very fast IGBT

Features

- High current capability
- High frequency operation
- Low C_{RES}/C_{IES} ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode

Applications

- High frequency inverters
- SMPS and PFC in both hard switching and resonant topologies
- UPS
- Motor drivers



Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The suffix "V" identifies a family optimized for high frequency.

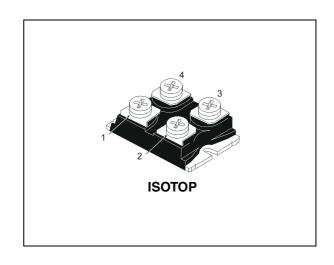


Figure 1. Internal schematic diagram

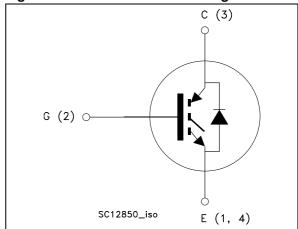


Table 1. Device summary

Order code	Marking	Package	Packaging
STGE50NC60VD	GE50NC60VD	ISOTOP	Tube

Contents STGE50NC60VD

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STGE50NC60VD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	٧
I _C ⁽¹⁾	Collector current (continuous) at T _C = 25 °C	90	Α
I _C ⁽¹⁾	Collector current (continuous) at T _C = 100 °C	50	Α
I _{CL} (2)	Turn-off latching current	200	Α
I _{CP} (3)	Pulsed collector current	200	Α
V _{GE}	Gate-emitter voltage	± 20	V
I _F	Diode RMS forward current at T _C =25°C	30	Α
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sinusoidal	120	Α
P _{TOT}	Total dissipation at T _C = 25 °C 260		W
Tj	Operating junction temperature	-55 to 150	°C

^{1.} Calculated according to the iterative formula

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. $V_{clamp} = 80\%$ of V_{CES} , $T_j = 150$ °C, $R_G = 10 \Omega$, $V_{GE} = 15 V$
- 3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case IGBT	0.48	°C/W
R _{thj-case}	Thermal resistance junction-case diode	1.6	°C/W
R _{thj-amb}	Thermal resistance junction-amb	30	°C/W

Electrical characteristics STGE50NC60VD

2 Electrical characteristics

 $(T_J = 25 \, ^{\circ}C \, unless \, otherwise \, specified)$

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V _{CE(sat)}	Collector-emitter saturation voltage	V_{GE} = 15 V, I_{C} = 40 A V_{GE} = 15 V, I_{C} =40 A, T_{j} =125 °C		1.9	2.5	V V
V _{GE(th)}	Gate threshold voltage	V _{CE} = V _{GE} , I _C = 250 μA	3.75		5.75	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} =600 V V _{CE} = 600 V, T _j = 125 °C			150 1	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20 V			±100	nA
g _{fs} ⁽¹⁾	Forward transconductance	$V_{CE} = 15 V_{,} I_{C} = 20 A$		20		S

^{1.} Pulsed: pulse duration= 300 μ s, duty cycle 1.5%

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0$	-	4550 350 105	-	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 390 \text{ V}, I_{C} = 40 \text{ A},$ $V_{GE} = 15 \text{ V},$ see Figure 17	-	214 30 96	-	nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390 V, I_{C} = 40 A R_{G} = 3.3 Ω , V_{GE} = 15 V, see <i>Figure 16</i>	-	43 17 2060	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V, } I_{C} = 40 \text{ A}$ $R_{G} = 3.3 \Omega, V_{GE} = 15 \text{ V,}$ $T_{j} = 125 ^{\circ}\text{C}$ see <i>Figure 16</i>	-	42 19 1900	-	ns ns A/µs
t _{r(Voff)} t _{d(Voff)} t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390 V, I_{C} = 40 A R_{G} = 3.3 Ω , V_{GE} = 15 V, see <i>Figure 16</i>	-	25 140 45	-	ns ns ns
t _{r(Voff)} t _{d(Voff)} t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V, } I_{C} = 40 \text{ A}$ $R_{G} = 3.3 \Omega, V_{GE} = 15 \text{ V,}$ $T_{j} = 125 ^{\circ}\text{C}$ see <i>Figure 16</i>	-	60 170 77	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 390 V, I_{C} = 40 A R_{G} = 3.3 Ω , V_{GE} = 15 V, see <i>Figure 18</i>	-	330 720 1050	450 970 1420	μJ μJ μJ
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}, I_{C} = 40 \text{ A}$ $R_{G} = 3.3 \Omega, V_{GE} = 15 \text{ V},$ $T_{j} = 125 ^{\circ}\text{C}$ see <i>Figure 18</i>	-	640 1400 2040		μJ μJ μJ

Eon is the turn-on losses when a typical diode is used in the test circuit in *Figure 18* If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25 °C and 125 °C)

^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGE50NC60VD

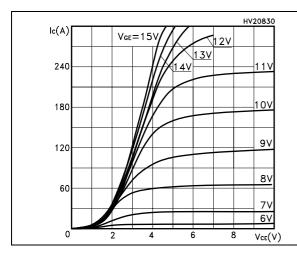
Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 20 A I _F = 20 A, Tj = 125°C	-	1.5 1	2.2	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 40 \text{ V},$ di/dt = 100 A/ μ s see <i>Figure 19</i>	-	44 66 3		ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 40 \text{ V},$ $T_j = 125 ^{\circ}\text{C}, \text{di/dt} = 100 \text{A/}\mu\text{s}$ see <i>Figure 19</i>	-	88 237 5.4		ns nC A

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



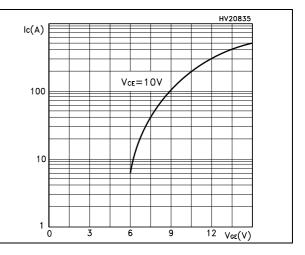
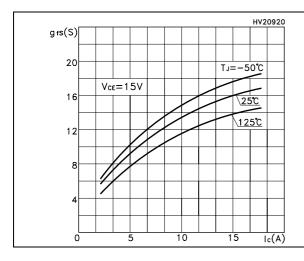


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature



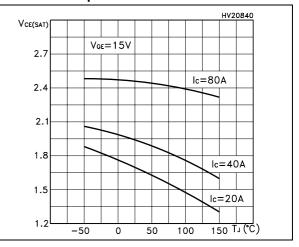
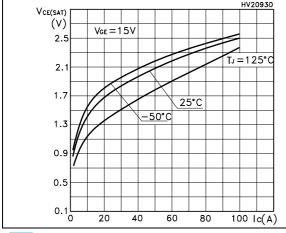
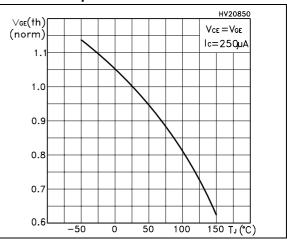


Figure 6. Collector-emitter on voltage vs collector current

Figure 7. Normalized gate threshold vs temperature





Electrical characteristics STGE50NC60VD

Figure 8. Normalized breakdown voltage vs Figure 9. Gate charge vs gate-emitter voltage temperature

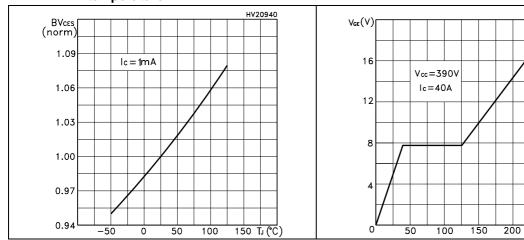


Figure 10. Capacitance variations

Figure 11. Total switching losses vs temperature

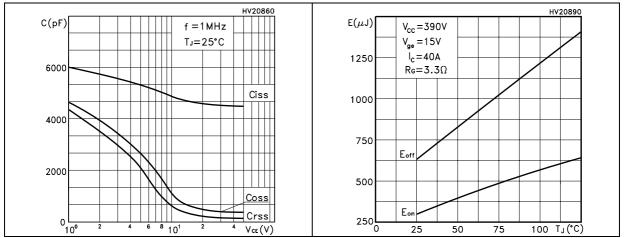
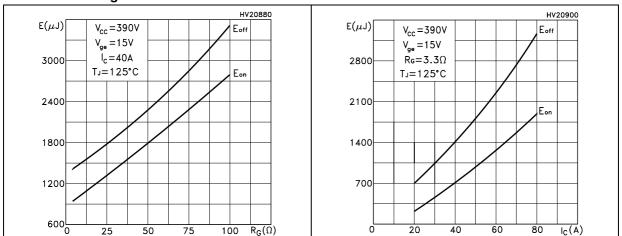


Figure 12. Total switching losses vs gate charge resistance

Figure 13. Total switching losses vs collector current



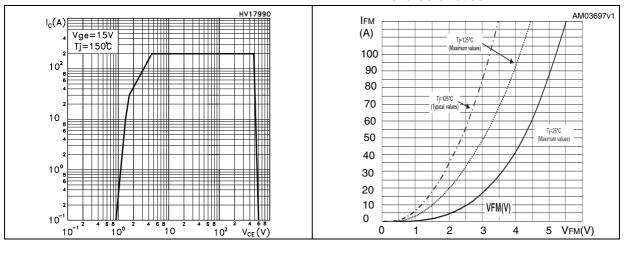
HV20870

250

Qg(nC)

Figure 14. Turn-off SOA

Figure 15. Emitter-collector diode characteristics



Test circuits STGE50NC60VD

3 Test circuits

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

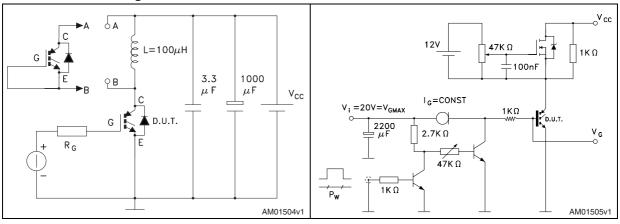
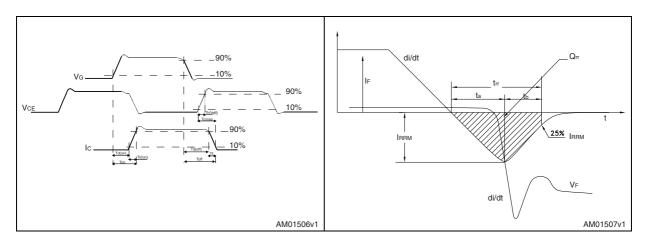


Figure 18. Switching waveform

Figure 19. Diode recovery time waveform



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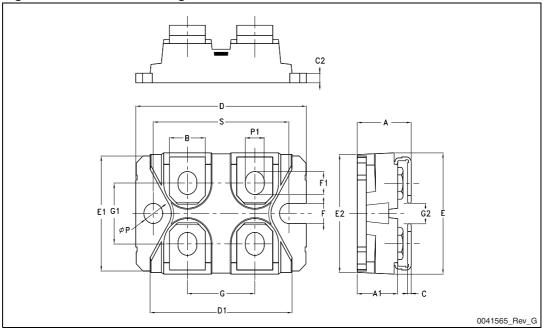
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 9. ISOTOP mechanical data

Table 5.	- Inconanical date	•	
Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	11.80		12.20
A1	8.90		9.10
В	7.80		8.20
С	0.75		0.85
C2	1.95		2.05
D	37.80		38.20
D1	31.50		31.70
E	25.15		25.50
E1	23.85		24.15
E2		24.80	
G	14.90		15.10
G1	12.60		12.80
G2	3.50		4.30
F	4.10		4.30
F1	4.60		5
фР	4		4.30
P1	4		4.40
S	30.10		30.30

Figure 20. ISOTOP drawing



STGE50NC60VD Revision history

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
11-Oct-2006	1	First release
24-Jul-2007	2	Internal schematic diagram has been updated Figure 1
23-Apr-2009	3	Updated: mechanical data

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